DS1307
64 x 8, Serial, I²C Real-Time Clock

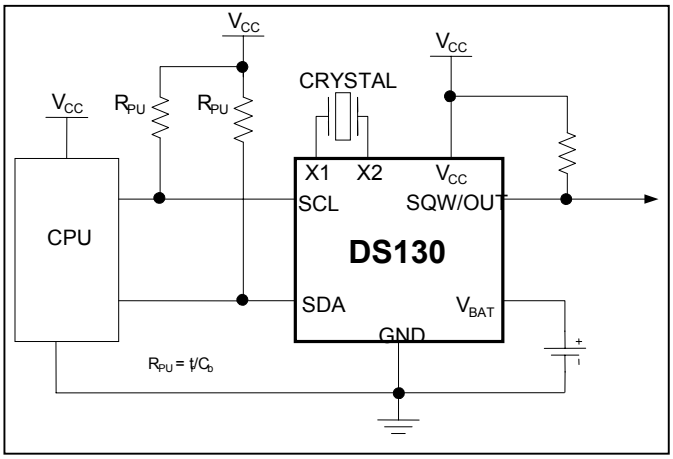
GENERAL DESCRIPTION

The DS1307 serial real-time clock (RTC) is a low-power, full binary-coded decimal (BCD) clock/calendar plus 56 bytes of NV SRAM. Address and data are transferred serially through an I²C, bidirectional bus. The clock/calendar provides seconds, minutes, hours, day, date, month, and year information. The end of the month date is automatically adjusted for months with fewer than 31 days, including corrections for leap year. The clock operates in either the 24-hour or 12-hour format with AM/PM indicator. The DS1307 has a built-in power-sense circuit that detects power failures and automatically switches to the backup supply. Timekeeping operation continues while the part operates from the backup supply.

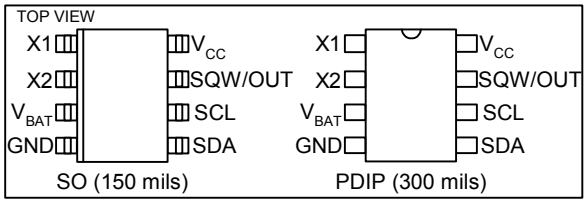
FEATURES

- Real-Time Clock (RTC) Counts Seconds, Minutes, Hours, Date of the Month, Month, Day of the week, and Year with Leap-Year Compensation Valid Up to 2100
- 56-Byte, Battery-Backed, General-Purpose RAM with Unlimited Writes
- I²C Serial Interface
- Programmable Square-Wave Output Signal
- Automatic Power-Fail Detect and Switch Circuitry
- Consumes Less than 500nA in Battery-Backup Mode with Oscillator Running
- Optional Industrial Temperature Range: -40°C to +85°C
- Available in 8-Pin Plastic DIP or SO
- Underwriters Laboratories (UL) Recognized

TYPICAL OPERATING CIRCUIT



PIN CONFIGURATIONS



ORDERING INFORMATION

PART	TEMP RANGE	VOLTAGE (V)	PIN-PACKAGE	TOP MARK*
DS1307+	0°C to +70°C	5.0	8 PDIP (300 mils)	DS1307
DS1307N+	-40°C to +85°C	5.0	8 PDIP (300 mils)	DS1307N
DS1307Z+	0°C to +70°C	5.0	8 SO (150 mils)	DS1307
DS1307ZN+	-40°C to +85°C	5.0	8 SO (150 mils)	DS1307N
DS1307Z+T&R	0°C to +70°C	5.0	8 SO (150 mils) Tape and Reel	DS1307
DS1307ZN+T&R	-40°C to +85°C	5.0	8 SO (150 mils) Tape and Reel	DS1307N

+Denotes a lead-free/RoHS-compliant package.
**A "+" anywhere on the top mark indicates a lead-free package. An "N" anywhere on the top mark indicates an industrial temperature range device.*

REV: 100208

ABSOLUTE MAXIMUM RATINGS

Voltage Range on Any Pin Relative to Ground .....-0.5V to +7.0V
Operating Temperature Range (Noncondensing)
Commercial.....0°C to +70°C
Industrial .....-40°C to +85°C
Storage Temperature Range ..... -55°C to +125°C
Soldering Temperature (DIP, leads).....+260°C for 10 seconds
Soldering Temperature (surface mount)…..…….Refer to the JPC/JEDEC J-STD-020 Specification.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED DC OPERATING CONDITIONS

(T_A = 0°C to +70°C, T_A = -40°C to +85°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V_{CC}		4.5	5.0	5.5	V
Logic 1 Input	V_{IH}		2.2		V_{CC} + 0.3	V
Logic 0 Input	V_{IL}		-0.3		+0.8	V
V_{BAT} Battery Voltage	V_{BAT}		2.0	3	3.5	V

DC ELECTRICAL CHARACTERISTICS

(**V_{CC} = 4.5V to 5.5V**; T_A = 0°C to +70°C, T_A = -40°C to +85°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Leakage (SCL)	I_{LI}		-1		1	µA
I/O Leakage (SDA, SQW/OUT)	I_{LO}		-1		1	µA
Logic 0 Output (I_{OL} = 5mA)	V_{OL}				0.4	V
Active Supply Current (f_{SCL} = 100kHz)	I_{CCA}				1.5	mA
Standby Current	I_{CCS}	(Note 3)			200	µA
V_{BAT} Leakage Current	I_{BATLKG}			5	50	nA
Power-Fail Voltage (V_{BAT} = 3.0V)	V_{PF}		1.216 x V_{BAT}	1.25 x V_{BAT}	1.284 x V_{BAT}	V

DC ELECTRICAL CHARACTERISTICS

(**V_{CC} = 0V, V_{BAT} = 3.0V**; T_A = 0°C to +70°C, T_A = -40°C to +85°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
V_{BAT} Current (OSC ON); SQW/OUT OFF	I_{BAT1}			300	500	nA
V_{BAT} Current (OSC ON); SQW/OUT ON (32kHz)	I_{BAT2}			480	800	nA
V_{BAT} Data-Retention Current (Oscillator Off)	I_{BATDR}			10	100	nA

WARNING: Negative undershoots below -0.3V while the part is in battery-backed mode may cause loss of data.

AC ELECTRICAL CHARACTERISTICS

(V_{CC} **= 4.5V to 5.5V**; T_A = 0°C to +70°C, T_A = -40°C to +85°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SCL Clock Frequency	f_{SCL}		0		100	kHz
Bus Free Time Between a STOP and START Condition	t_{BUF}		4.7			µs
Hold Time (Repeated) START Condition	$t_{HD:STA}$	(Note 4)	4.0			µs
LOW Period of SCL Clock	t_{LOW}		4.7			µs
HIGH Period of SCL Clock	t_{HIGH}		4.0			µs
Setup Time for a Repeated START Condition	$t_{SU:STA}$		4.7			µs
Data Hold Time	$t_{HD:DAT}$		0			µs
Data Setup Time	$t_{SU:DAT}$	(Notes 5, 6)	250			ns
Rise Time of Both SDA and SCL Signals	t_R				1000	ns
Fall Time of Both SDA and SCL Signals	t_F				300	ns
Setup Time for STOP Condition	$t_{SU:STO}$		4.7			µs

CAPACITANCE

(T_A = +25°C)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Pin Capacitance (SDA, SCL)	$C_{I/O}$				10	pF
Capacitance Load for Each Bus Line	C_B	(Note 7)			400	pF

Note 1: All voltages are referenced to ground.

Note 2: Limits at -40°C are guaranteed by design and are not production tested.

Note 3: I_{CCS} specified with V_{CC} = 5.0V and SDA, SCL = 5.0V.

Note 4: After this period, the first clock pulse is generated.

Note 5: A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the $V_{IH(MIN)}$ of the SCL signal) to bridge the undefined region of the falling edge of SCL.

Note 6: The maximum $t_{HD:DAT}$ only has to be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal.

Note 7: C_B—total capacitance of one bus line in pF.

TIMING DIAGRAM

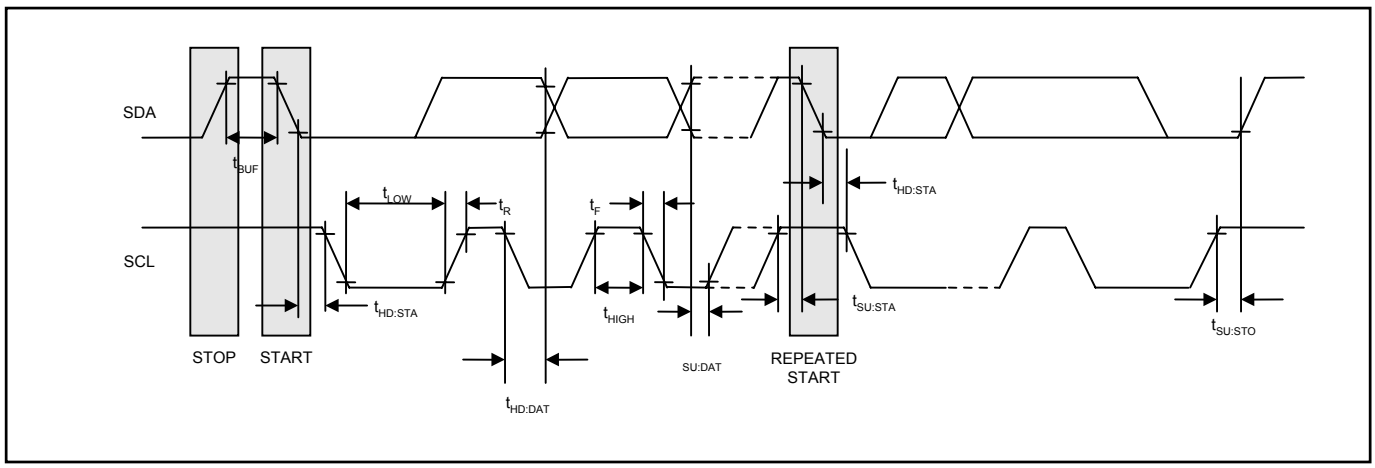
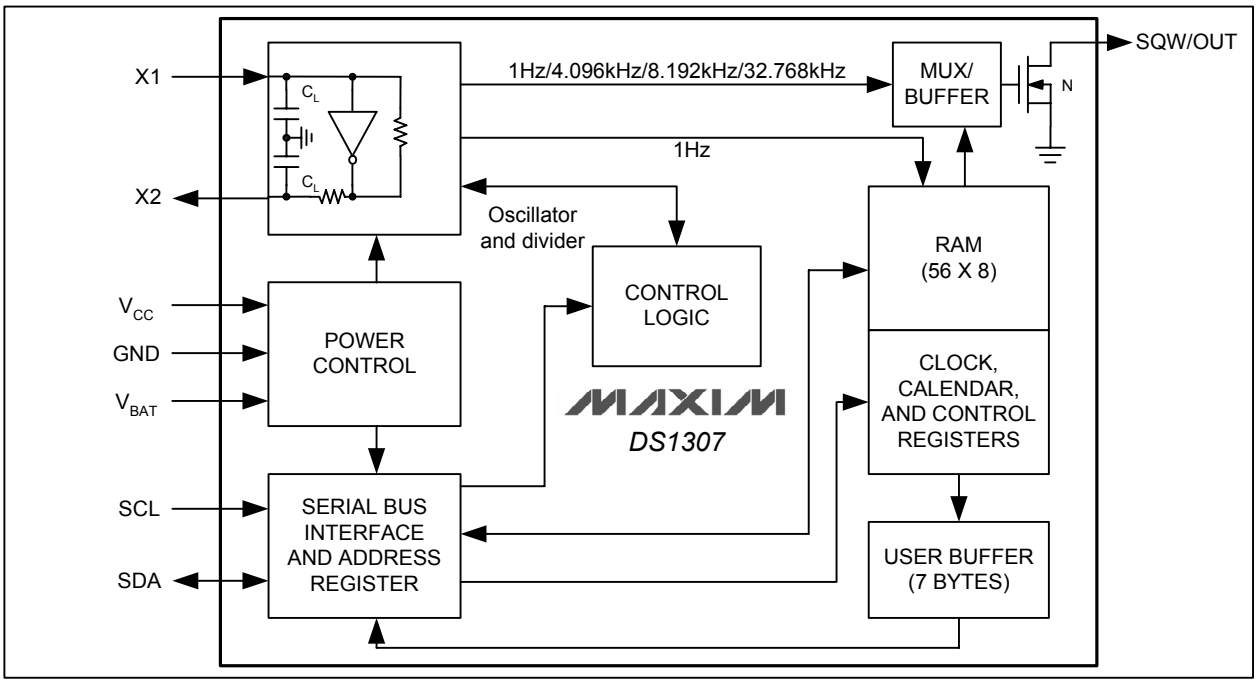
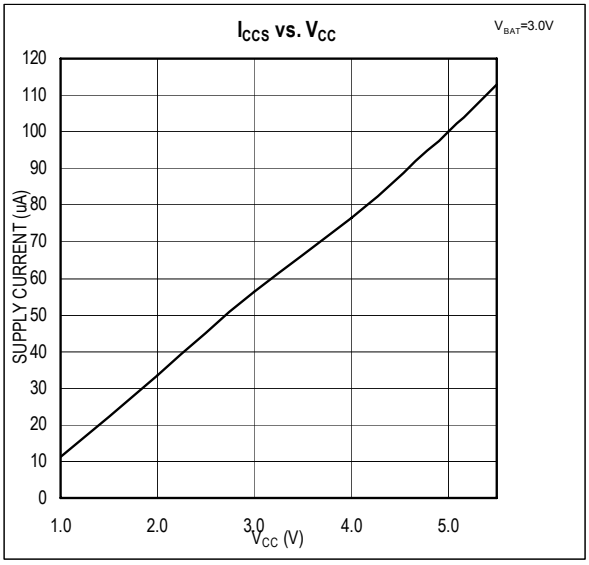


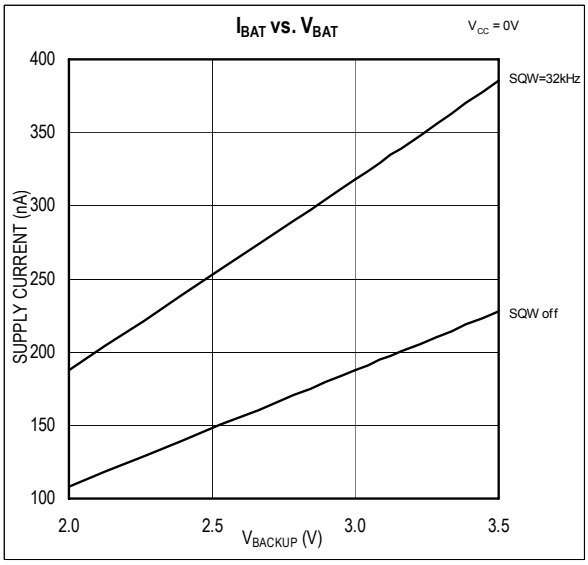
Figure 1. Block Diagram

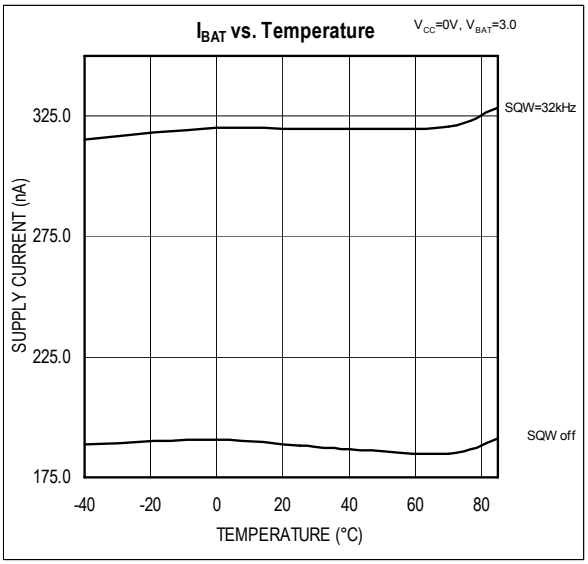


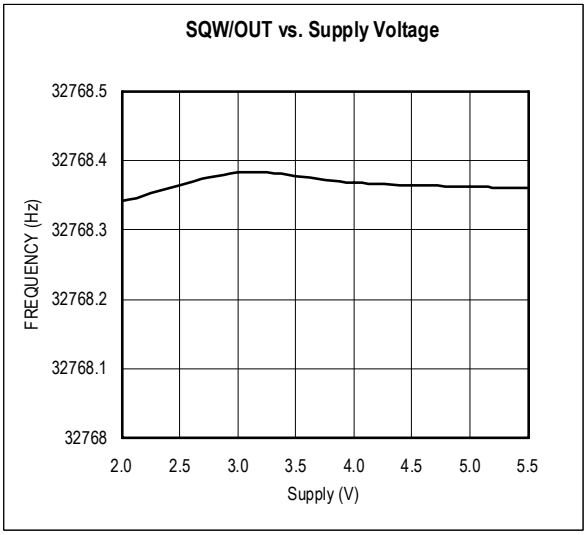
TYPICAL OPERATING CHARACTERISTICS

(V_{CC} = 5.0V, T_A = +25°C, unless otherwise noted.)









PIN DESCRIPTION

PIN	NAME	FUNCTION
1	X1	Connections for Standard 32.768kHz Quartz Crystal. The internal oscillator circuitry is designed for operation with a crystal having a specified load capacitance (C_L) of 12.5pF. X1 is the input to the oscillator and can optionally be connected to an external 32.768kHz oscillator. The output of the internal oscillator, X2, is floated if an external oscillator is connected to X1. **Note:** For more information on crystal selection and crystal layout considerations, refer to *Application Note 58: Crystal Considerations with Dallas Real-Time Clocks*.
2	X2	
3	V_{BAT}	Backup Supply Input for Any Standard 3V Lithium Cell or Other Energy Source. Battery voltage must be held between the minimum and maximum limits for proper operation. Diodes in series between the battery and the V_{BAT} pin may prevent proper operation. If a backup supply is not required, V_{BAT} must be grounded. The nominal power-fail trip point (V_{PF}) voltage at which access to the RTC and user RAM is denied is set by the internal circuitry as 1.25 x V_{BAT} nominal. A lithium battery with 48mAh or greater will back up the DS1307 for more than 10 years in the absence of power at +25°C. UL recognized to ensure against reverse charging current when used with a lithium battery. Go to: www.maxim-ic.com/qa/info/ul/.
4	GND	Ground
5	SDA	Serial Data Input/Output. SDA is the data input/output for the I²C serial interface. The SDA pin is open drain and requires an external pullup resistor. The pullup voltage can be up to 5.5V regardless of the voltage on V_{CC}.
6	SCL	Serial Clock Input. SCL is the clock input for the I²C interface and is used to synchronize data movement on the serial interface. The pullup voltage can be up to 5.5V regardless of the voltage on V_{CC}.
7	SQW/OUT	Square Wave/Output Driver. When enabled, the SQWE bit set to 1, the SQW/OUT pin outputs one of four square-wave frequencies (1Hz, 4kHz, 8kHz, 32kHz). The SQW/OUT pin is open drain and requires an external pullup resistor. SQW/OUT operates with either V_{CC} or V_{BAT} applied. The pullup voltage can be up to 5.5V regardless of the voltage on V_{CC}. If not used, this pin can be left floating.
8	V_{CC}	Primary Power Supply. When voltage is applied within normal limits, the device is fully accessible and data can be written and read. When a backup supply is connected to the device and V_{CC} is below V_{TP}, read and writes are inhibited. However, the timekeeping function continues unaffected by the lower input voltage.

DETAILED DESCRIPTION

The DS1307 is a low-power clock/calendar with 56 bytes of battery-backed SRAM. The clock/calendar provides seconds, minutes, hours, day, date, month, and year information. The date at the end of the month is automatically adjusted for months with fewer than 31 days, including corrections for leap year. The DS1307 operates as a slave device on the I²C bus. Access is obtained by implementing a START condition and providing a device identification code followed by a register address. Subsequent registers can be accessed sequentially until a STOP condition is executed. When V_{CC} falls below 1.25 x V_{BAT}, the device terminates an access in progress and resets the device address counter. Inputs to the device will not be recognized at this time to prevent erroneous data from being written to the device from an out-of-tolerance system. When V_{CC} falls below V_{BAT}, the device switches into a low-current battery-backup mode. Upon power-up, the device switches from battery to V_{CC} when V_{CC} is greater than V_{BAT} +0.2V and recognizes inputs when V_{CC} is greater than 1.25 x V_{BAT}. The block diagram in Figure 1 shows the main elements of the serial RTC.

OSCILLATOR CIRCUIT

The DS1307 uses an external 32.768kHz crystal. The oscillator circuit does not require any external resistors or capacitors to operate. Table 1 specifies several crystal parameters for the external crystal. Figure 1 shows a functional schematic of the oscillator circuit. If using a crystal with the specified characteristics, the startup time is usually less than one second.

CLOCK ACCURACY

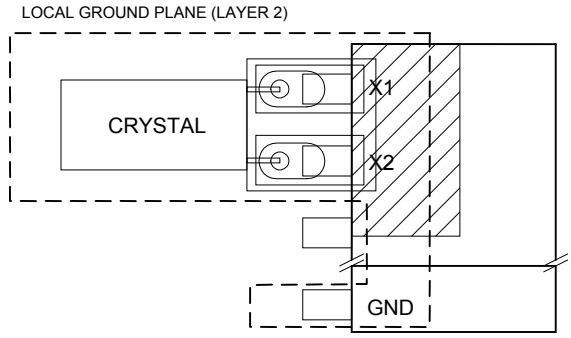
The accuracy of the clock is dependent upon the accuracy of the crystal and the accuracy of the match between the capacitive load of the oscillator circuit and the capacitive load for which the crystal was trimmed. Additional error will be added by crystal frequency drift caused by temperature shifts. External circuit noise coupled into the oscillator circuit may result in the clock running fast. Refer to Application Note 58: *Crystal Considerations with Dallas Real-Time Clocks* for detailed information.

Table 1. Crystal Specifications*

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS
Nominal Frequency	f_O		32.768		kHz
Series Resistance	ESR			45	kΩ
Load Capacitance	C_L		12.5		pF

**The crystal, traces, and crystal input pins should be isolated from RF generating signals. Refer to* Application Note 58: Crystal Considerations for Dallas Real-Time Clocks *for additional specifications.*

Figure 2. Recommended Layout for Crystal



NOTE: AVOID ROUTING SIGNAL LINES IN THE CROSSHATCHED AREA (UPPER LEFT QUADRANT) OF THE PACKAGE UNLESS THERE IS A GROUND PLANE BETWEEN THE SIGNAL LINE AND THE DEVICE PACKAGE.

RTC AND RAM ADDRESS MAP

Table 2 shows the address map for the DS1307 RTC and RAM registers. The RTC registers are located in address locations 00h to 07h. The RAM registers are located in address locations 08h to 3Fh. During a multibyte access, when the address pointer reaches 3Fh, the end of RAM space, it wraps around to location 00h, the beginning of the clock space.

CLOCK AND CALENDAR

The time and calendar information is obtained by reading the appropriate register bytes. Table 2 shows the RTC registers. The time and calendar are set or initialized by writing the appropriate register bytes. The contents of the time and calendar registers are in the BCD format. The day-of-week register increments at midnight. Values that correspond to the day of week are user-defined but must be sequential (i.e., if 1 equals Sunday, then 2 equals Monday, and so on.) Illogical time and date entries result in undefined operation. Bit 7 of Register 0 is the clock halt (CH) bit. When this bit is set to 1, the oscillator is disabled. When cleared to 0, the oscillator is enabled. On first application of power to the device the time and date registers are typically reset to 01/01/00 01 00:00:00 (MM/DD/YY DOW HH:MM:SS). The CH bit in the seconds register will be set to a 1. The clock can be halted whenever the timekeeping functions are not required, which minimizes current (I_{BATDR}).

The DS1307 can be run in either 12-hour or 24-hour mode. Bit 6 of the hours register is defined as the 12-hour or 24-hour mode-select bit. When high, the 12-hour mode is selected. In the 12-hour mode, bit 5 is the AM/PM bit with logic high being PM. In the 24-hour mode, bit 5 is the second 10-hour bit (20 to 23 hours). The hours value must be re-entered whenever the 12/24-hour mode bit is changed.

When reading or writing the time and date registers, secondary (user) buffers are used to prevent errors when the internal registers update. When reading the time and date registers, the user buffers are synchronized to the internal registers on any I²C START. The time information is read from these secondary registers while the clock continues to run. This eliminates the need to re-read the registers in case the internal registers update during a read. The divider chain is reset whenever the seconds register is written. Write transfers occur on the I²C acknowledge from the DS1307. Once the divider chain is reset, to avoid rollover issues, the remaining time and date registers must be written within one second.

Table 2. Timekeeper Registers

ADDRESS	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	FUNCTION	RANGE
00h	CH	10 Seconds			Seconds				Seconds	00–59
01h	0	10 Minutes			Minutes				Minutes	00–59
02h	0	12	10 Hour	10 Hour	Hours				Hours	1–12 +AM/PM 00–23
		24	PM/ AM							
03h	0	0	0	0	0	DAY			Day	01–07
04h	0	0	10 Date		Date				Date	01–31
05h	0	0	0	10 Month	Month				Month	01–12
06h	10 Year				Year				Year	00–99
07h	OUT	0	0	SQWE	0	0	RS1	RS0	Control	—
08h–3Fh									RAM 56 x 8	00h–FFh

0 = Always reads back as 0.

CONTROL REGISTER

The DS1307 control register is used to control the operation of the SQW/OUT pin.

BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
OUT	0	0	SQWE	0	0	RS1	RS0

Bit 7: Output Control (OUT). This bit controls the output level of the SQW/OUT pin when the square-wave output is disabled. If SQWE = 0, the logic level on the SQW/OUT pin is 1 if OUT = 1 and is 0 if OUT = 0. On initial application of power to the device, this bit is typically set to a 0.

Bit 4: Square-Wave Enable (SQWE). This bit, when set to logic 1, enables the oscillator output. The frequency of the square-wave output depends upon the value of the RS0 and RS1 bits. With the square-wave output set to 1Hz, the clock registers update on the falling edge of the square wave. On initial application of power to the device, this bit is typically set to a 0.

Bits 1 and 0: Rate Select (RS[1:0]). These bits control the frequency of the square-wave output when the square-wave output has been enabled. The following table lists the square-wave frequencies that can be selected with the RS bits. On initial application of power to the device, these bits are typically set to a 1.

RS1	RS0	SQW/OUT OUTPUT	SQWE	OUT
0	0	1Hz	1	X
0	1	4.096kHz	1	X
1	0	8.192kHz	1	X
1	1	32.768kHz	1	X
X	X	0	0	0
X	X	1	0	1

I²C DATA BUS

The DS1307 supports the I²C protocol. A device that sends data onto the bus is defined as a transmitter and a device receiving data as a receiver. The device that controls the message is called a master. The devices that are controlled by the master are referred to as slaves. The bus must be controlled by a master device that generates the serial clock (SCL), controls the bus access, and generates the START and STOP conditions. The DS1307 operates as a slave on the I²C bus.

Figures 3, 4, and 5 detail how data is transferred on the I²C bus.

- Data transfer can be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is high will be interpreted as control signals.

Accordingly, the following bus conditions have been defined:

Bus not busy: Both data and clock lines remain HIGH.

START data transfer: A change in the state of the data line, from HIGH to LOW, while the clock is HIGH, defines a START condition.

STOP data transfer: A change in the state of the data line, from LOW to HIGH, while the clock line is HIGH, defines the STOP condition.

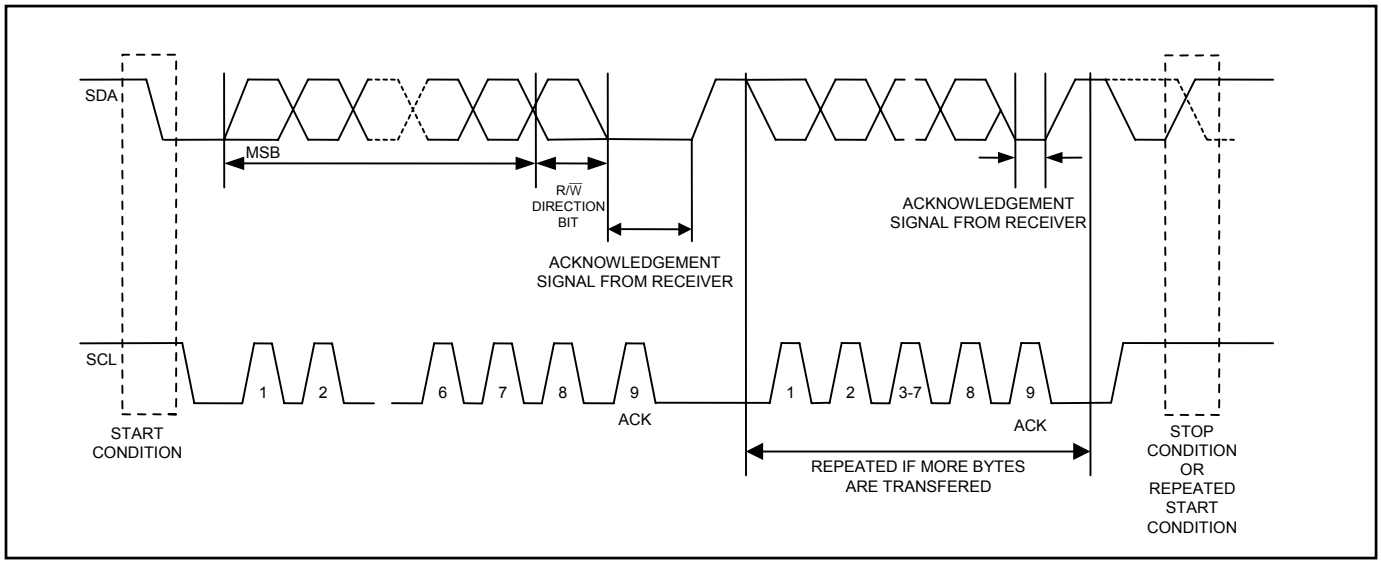
Data valid: The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal. The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of data bytes transferred between START and STOP conditions is not limited, and is determined by the master device. The information is transferred byte-wise and each receiver acknowledges with a ninth bit. Within the I²C bus specifications a standard mode (100kHz clock rate) and a fast mode (400kHz clock rate) are defined. The DS1307 operates in the standard mode (100kHz) only.

Acknowledge: Each receiving device, when addressed, is obliged to generate an acknowledge after the reception of each byte. The master device must generate an extra clock pulse which is associated with this acknowledge bit.

A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. A master must signal an end of data to the slave by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave must leave the data line HIGH to enable the master to generate the STOP condition.

Figure 3. Data Transfer on I²C Serial Bus



Depending upon the state of the R/$\overline{W}$ bit, two types of data transfer are possible:

1. **Data transfer from a master transmitter to a slave receiver.** The first byte transmitted by the master is the slave address. Next follows a number of data bytes. The slave returns an acknowledge bit after each received byte. Data is transferred with the most significant bit (MSB) first.

2. **Data transfer from a slave transmitter to a master receiver.** The first byte (the slave address) is transmitted by the master. The slave then returns an acknowledge bit. This is followed by the slave transmitting a number of data bytes. The master returns an acknowledge bit after all received bytes other than the last byte. At the end of the last received byte, a “not acknowledge” is returned.

   The master device generates all the serial clock pulses and the START and STOP conditions. A transfer is ended with a STOP condition or with a repeated START condition. Since a repeated START condition is also the beginning of the next serial transfer, the bus will not be released. Data is transferred with the most significant bit (MSB) first.

The DS1307 can operate in the following two modes:

1. **Slave Receiver Mode (Write Mode):** Serial data and clock are received through SDA and SCL. After each byte is received an acknowledge bit is transmitted. START and STOP conditions are recognized as the beginning and end of a serial transfer. Hardware performs address recognition after reception of the slave address and direction bit (see Figure 4). The slave address byte is the first byte received after the master generates the START condition. The slave address byte contains the 7-bit DS1307 address, which is 1101000, followed by the direction bit (R/$\overline{W}$), which for a write is 0. After receiving and decoding the slave address byte, the DS1307 outputs an acknowledge on SDA. After the DS1307 acknowledges the slave address + write bit, the master transmits a word address to the DS1307. This sets the register pointer on the DS1307, with the DS1307 acknowledging the transfer. The master can then transmit zero or more bytes of data with the DS1307 acknowledging each byte received. The register pointer automatically increments after each data byte are written. The master will generate a STOP condition to terminate the data write.

2. **Slave Transmitter Mode (Read Mode):** The first byte is received and handled as in the slave receiver mode. However, in this mode, the direction bit will indicate that the transfer direction is reversed. The DS1307 transmits serial data on SDA while the serial clock is input on SCL. START and STOP conditions are recognized as the beginning and end of a serial transfer (see Figure 5). The slave address byte is the first byte received after the START condition is generated by the master. The slave address byte contains the 7-bit DS1307 address, which is 1101000, followed by the direction bit (R/$\overline{W}$), which is 1 for a read. After receiving and decoding the slave address the DS1307 outputs an acknowledge on SDA. The DS1307 then begins to transmit data starting with the register address pointed to by the register pointer. If the register pointer is not written to before the initiation of a read mode the first address that is read is the last one stored in the register pointer. The register pointer automatically increments after each byte are read. The DS1307 must receive a Not Acknowledge to end a read.

Figure 4. Data Write—Slave Receiver Mode

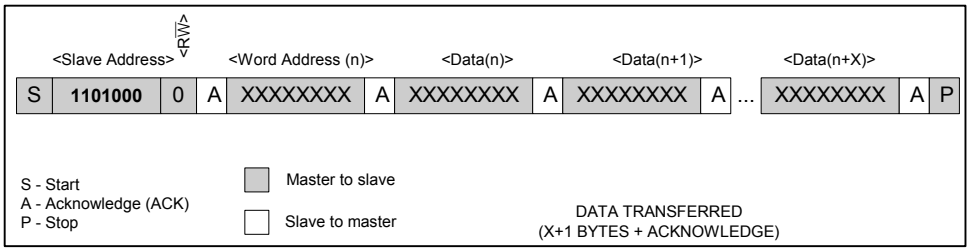


Figure 5. Data Read—Slave Transmitter Mode

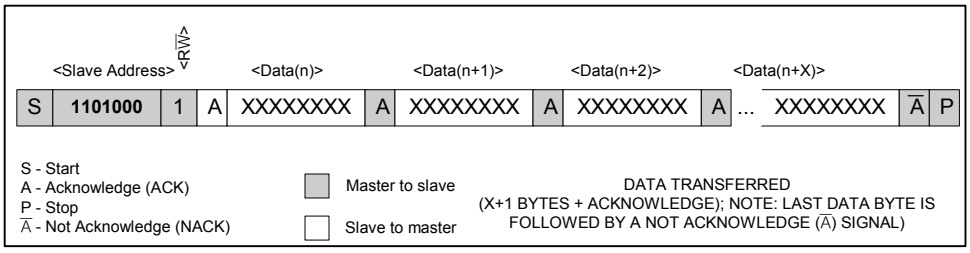
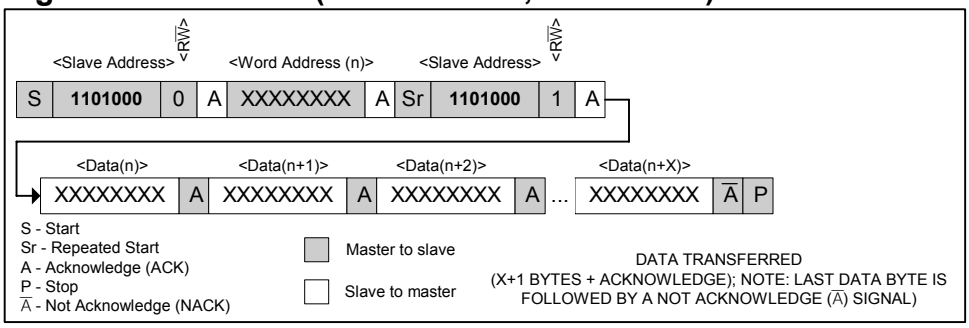


Figure 6. Data Read (Write Pointer, Then Read)—Slave Receive and Transmit



PACKAGE INFORMATION

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
8 PDIP	—	**21-0043**
8 SO	—	**21-0041**

REVISION HISTORY

REVISION DATE	DESCRIPTION	PAGES CHANGED
100208	Moved the *Typical Operating Circuit* and *Pin Configurations* to first page.	1
	Removed the leaded part numbers from the *Ordering Information* table.	1
	Added an open-drain transistor to SQW/OUT in the block diagram (Figure 1).	4
	Added the pullup voltage range for SDA, SCL, and SQW/OUT to the *Pin Description* table and noted that SQW/OUT can be left open if not used.	6
	Added default time and date values on first application of power to the *Clock and Calendar* section and deleted the note that initial power-on state is not defined.	8
	Added default on initial application of power to bit info in the *Control Register* section.	9
	Updated the *Package Information* section to reflect new package outline drawing numbers.	13

Maxim/Dallas Semiconductor cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim/Dallas Semiconductor product. No circuit patent licenses are implied. Maxim/Dallas Semiconductor reserves the right to change the circuitry and specifications without notice at any time.

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

© 2008 Maxim Integrated Products

The Maxim logo is a registered trademark of Maxim Integrated Products, Inc. The Dallas logo is a registered trademark of Dallas Semiconductor Corporation.

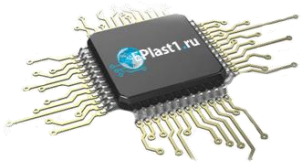
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.